Datasheet

AS1747 Low-Voltage, Dual SPDT, Audio Clickless Switch with Negative Rail Capability

1 General Description

The SPDT (single-pole/double-throw) switch AS1747 allows signals below ground to pass through without distortion. This analog switch is ideal for switching audio signals, due to the supply voltage from +1.8V to +5.5V and the low 0.4Ω on-resistance.

This SPDT switch is available in space-saving 10-pin TDFN 3x3 packages and operate over the -40°C to +85°C extended temperature range.

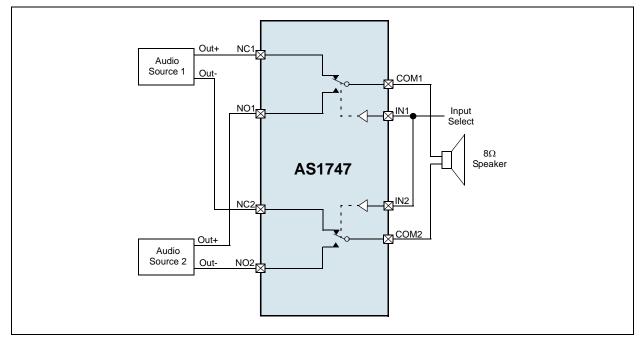
2 Key Features

- Distortion -Free Negative Signal Throughput Down to Vcc - 5.5V
- Low On-Resistance (R_{ON})
 0.4Ω at +2.7V Supply
- 0.25Ω On-Resistance Flatness
- 0.03Ω On-Resistance Matching
- +1.8V to 5.5V Supply Voltage
- -90dB Crosstalk (100kHz)
- -65dB Off-Isolation (100kHz)
- Available in 10-pin TDFN 3x3 Packages

3 Applications

The device is ideal for cell phones, PDAs and hand-held devices, notebook computers and MP3 players.

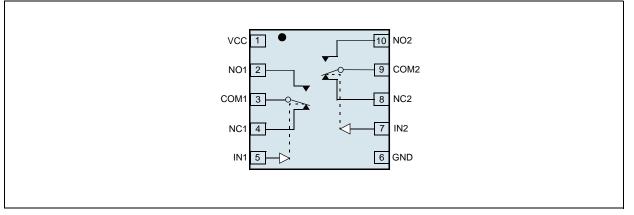
Figure 1. AS1747 - Typical Operating Circuit



4 Pinout

Pin Assignment

Figure 2. Pin Assignments (Top View)



Pin Description

Table 1. Pin Description

Pin Name	TDFN	Description			
VCC	1	Positive-Supply Voltage Input			
NO1	2	Analog Switch 1 - Normally Open Terminal			
COM1	3	Analog Switch 1 - Common Terminal			
NC1	4	Analog Switch 1 - Normally Closed Terminal			
IN1	5	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.			
GND	6	round			
IN2	7	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to N02.			
NC2	8	Analog Switch 2 - Normally Closed Terminal			
COM2	9	Analog Switch 2 - Common Terminal			
NO2	10	Analog Switch 2 - Normally Open Terminal			

5 Absolute Maximum Ratings

Stresses beyond those listed in Table 2 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Electrical Characteristics on page 4 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2.	Absolute	Maximum	Ratings
----------	----------	---------	---------

Parameter	Min	Max	Units	Comments
Vcc, IN_		+6.0	V	
COM_, NO_, NC_	Vcc - 6	Vcc + 0.3	V	
Closed-Switch Continuous Current COM_, NO_, NC_		±150	mA	
Open-Switch Continuous Current NO_, NC_		±30	mA	
Peak Current COM_, NO_, NC_ (pulsed at 1ms, 10% duty cycle)		±400	mA	
Continuous Power Dissipation (T _A = +70°C)	•			
10-Pin TDFN (derate 24.4mW/ºC above +70ºC)		1951	mW	
ESD		2	kV	HBM MIL-Std. 883E 3015.7 methods
Latchup Immunity	-200	+200	mA	@25°C, JEDEC 78
Operating Temperature Range	-40	+85	°C	
Junction Temperature		+150	°C	
Storage Temperature Range	-65	+150	°C	
Package Body Temperature		+260	°C	The reflow peak soldering temperature (body temperature) specified is in accordance with <i>IPC/JEDEC J-STD-</i> 020D "Moisture/Reflow Sensitivity Classification for Non-Hermetic Solid State Surface Mount Devices". The lead finish for Pb-free leaded packages is matte tin (100% Sn).

6 Electrical Characteristics

Vcc = +2.7V to +5.5V, T_A = -40°C to +85°C, unless otherwise specified. Typical values are at Vcc = +3.0V, T_A = +25°C, unless otherwise specified.

Table 3. Electrical Characteristics

Symbol	Parameter	Condition		Min	Тур	Max	Unit
Analog Sw	itch						
V _{NO_} V _{NC_} V _{COM_}	Analog Signal Range			Vcc - 5.5		Vcc	V
R _{ON(NC)}		$Vcc = 2.7V; V_{NC}$ or $V_{NO} = Vcc$ -	T _A = +25°C		0.4	0.85	
R _{ON(NO)}	On-Resistance	5.5V, -1V, 0V, 1V, 2V, Vcc; I _{COM} = 100mA	$T_A = T_{MIN}$ to T_{MAX}			0.95	Ω
	On-Resistance Match	Vcc = 2.7V, V_{NC} or V_{NO} = 0V,	T _A = +25°C		0.03	0.1	
ΔR_{ON}	Between Channels	$I_{COM} = 100 \text{mA}$	$T_A = T_{MIN}$ to T_{MAX}			0.15	Ω
	On-Resistance	Vcc = 2.7V; V _{NC} or V _{NC} = -1V,	T _A = +25°C		0.25	0.4	
R _{FLAT(NC)}	Flatness	$0V, 1V, 2V, Vcc; I_{COM} = 100 \text{mA}$	$T_A = T_{MIN}$ to T_{MAX}			0.45	Ω
I _{NO_(OFF)}	NO_, NC_	Vcc = 2.7V, switch open;	T _A = +25°C	-10		+10	
I _{NC_(OFF)}	Off-Leakage Current	V _{NC} _ or V _{NO} _ = -2.5V, +2.5V; V _{COM} _ = +2.5V, -2.5V	$T_A = T_{MIN}$ to T_{MAX}	-200		+200	nA
	COM	Vcc = $2.7V$, switch closed;	T _A = +25°C	-10		+10	
I _{COM_(ON)}	COM_ On-Leakage Current	V_{NC} or V_{NO} = -2.5V, +2.5V; or floating; V_{COM} = -2.5V, +2.5V, or floating	$T_A = T_{MIN}$ to T_{MAX}	-200		+200	nA
Dynamic C	haracteristics						
t _{ON}	Turn-On Time ¹	$V_{NO} = 2.5V$; for NO_, VIN_ = 0V to Vcc; for NC_, VIN_ = Vcc to 0V;	$T_A = +25^{\circ}C$ $T_A = T_{MIN}$ to		200	400	ns
		$R_L = 300\Omega$, $C_L = 35pF$, Figure 15	T _{MAX}			400	
4	1	$V_{NC} = 2.5V$; for NO_, $V_{IN} = V_{CC}$	T _A = +25°C		100	200	
toff	Turn-Off Time ¹	to 0V; for NC_, VIN_ = 0V to Vcc; R _L = 300Ω , C _L = $35pF$, Figure 15	$T_A = T_{MIN}$ to T_{MAX}			200	ns
t _D	Break-Before-Make Time Delay	$\label{eq:VN_state} \begin{array}{l} V_{N_} = 2.5V, \mbox{ for NO}_, \mbox{ Vin}_ = Vcc \mbox{ to } 0V; \mbox{ for NC}_, \\ V_{IN_} = 0V \mbox{ to } Vcc; \mbox{ R}_L = 300\Omega, \mbox{ C}_L = 35pF, \\ Figure \mbox{ 16} \end{array}$			200		ns
Q	Charge Injection	V_{COM} = 0V, R_{S} = 0 Ω , C_{L} = 1.0n	F, Figure 17		2		рС
V _{ISO}	Off-Isolation	$\label{eq:Vcc} \begin{array}{l} Vcc = 5V, f = 100kHz, V_{COM} = 1V_{RMS}, R_L = \\ 50\Omega, C_L = 5pF, Figure 18 \end{array}$			-65		dB
V _{CT}	Crosstalk	$\label{eq:Vcc} \begin{array}{l} \mbox{Vcc} = 5\mbox{V}, \mbox{f} = 100\mbox{kHz}, \mbox{V}_{COM} = 1\mbox{V}_{RMS}, \mbox{R}_{L} = \\ 50\mbox{\Omega}, \mbox{ C}_{L} = 5\mbox{pF}, \mbox{Figure 18} \end{array}$			-90		dB
PSRR	Power-Supply Rejection Ratio	$f = 10$ kHz, $V_{COM} = 1V_{RMS}$, $R_L = 50\Omega$, $C_L = 5$ pF			70		dB
BW	On-Channel-3dB Bandwidth	Vcc = 5V, Signal = 0dBm, $R_L = 50\Omega$, $C_L = 5pF$, Figure 18			31		MHz
THD	Total Harmonic Distortion	f = 20Hz to 20kHz, V_{COM} = 0.5V _{P-P} , DC Bias = 0, R _L = 32 Ω			0.01		%
$\begin{array}{c} C_{NO_(Off)} \\ C_{NC_(Off)} \end{array}$	NO_, NC_ Off- Capacitance	f = 1MHz, V_{COM} = 0.5 V_{P-P} , DC Bias = 0			63		pF

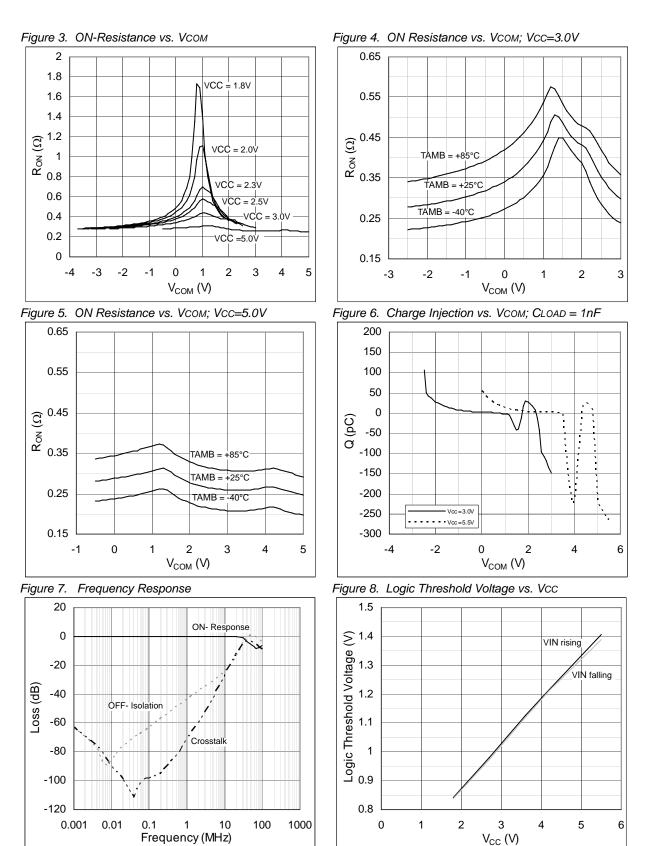
Symbol	Parameter Condition		Min	Тур	Max	Unit	
$C_{COM_(ON)}$	COM On-Capacitance	f = 1MHz, V_{COM} = 0.5 V_{P-P} , DC Bias = 0		196		pF	
Digital I/O	(IN_)						
Vін	Input Logic High Voltage	Vcc = 2.7V to 3.6V	1.4			V	
		Vcc = 4.2V to 5.5V	2.0				
VIL	Input Logic Low	Vcc = 2.7V to 3.6V			0.5	V	
VIL	Voltage	Vcc = 4.2V to 5.5V			0.8	v	
lin	Input Leakage Current	$VIN_{=} 0V$ to Vcc, Vcc = 5.5V	-1		+1	μA	
Power Supply							
Vcc	Power-Supply Range		1.8		5.5	V	
Icc	Supply Current	$Vcc = 5.5V$, $VIN_ = 0V$ or Vcc		0.01	1	μA	

Table 3. Electrical Characteristics (Continued)

1. Guaranteed by design

7 Typical Operating Characteristics

Vcc = 3.0V, T_A = $+25^{\circ}C$ (unless otherwise specified).



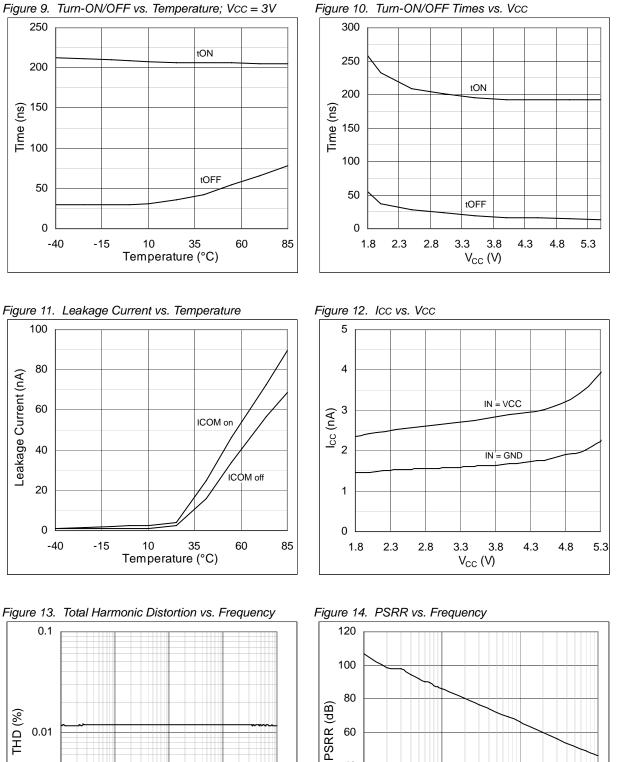


Figure 10. Turn-ON/OFF Times vs. Vcc

100

1000

Frequency (Hz)

10000

0.001

10

100000

40

20

0

0.1

100

10

1

Frequency (kHz)

8 Detailed Description

The AS1747 operates from a +1.8V to +5.5V supply and features a negative signal capability that allows signals below ground to pass through without distortion. A break-before-make switching and a low on-resistance is also included in this analog dual SPDT switch. The device is fully specified for a 3.0V application.

9 Application Information

Digital Control Inputs

The logic inputs of the AS1747 accept up to +5.5V independent of the supply voltage. Due to this a mixing of the logic levels in a system is possible. For example, with a +3.3V supply, IN_ can be driven low to GND and high to +5.5V. For a +1.8V supply voltage, the logic levels are 0.5V (low) and 1.4V (high); for a +5V supply voltage, the logic levels are 0.8V (low) and 2.0V (high).

Analog Signal Levels

The change of the on-resistance of the AS1747 is very little for analog input signals over the whole supply voltage range. The switches are bi-directional, so the NO_, NC_, and COM_ pins can be either inputs or outputs.

The AS1747 pass signals as low as Vcc - 5.5V, including signals below ground with minimal distortion.

Power-Supply Sequencing and Overvoltage Protection

Caution: Do not exceed the absolute maximum ratings since stresses beyond the listed ratings may cause permanent damage to the device.

Proper power-supply sequencing is recommended for all CMOS devices. Always apply Vcc before applying analog signals, especially if the analog signal is not current-limited.

10 Timing Diagrams

Figure 15. Switching Time

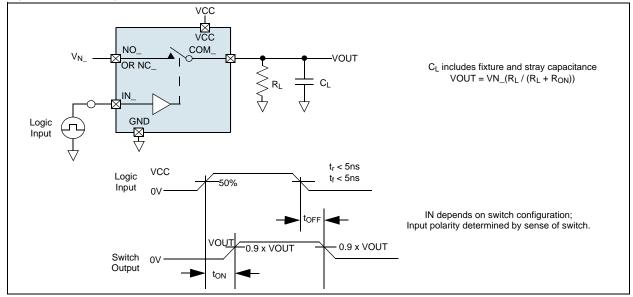
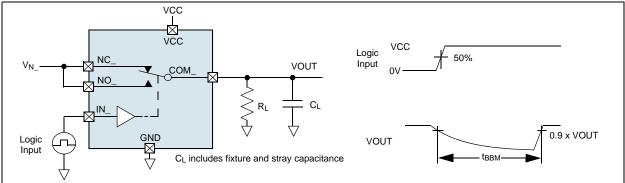
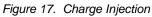
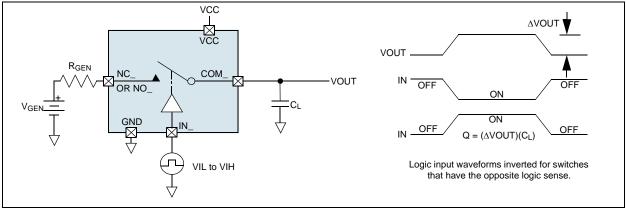
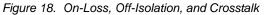


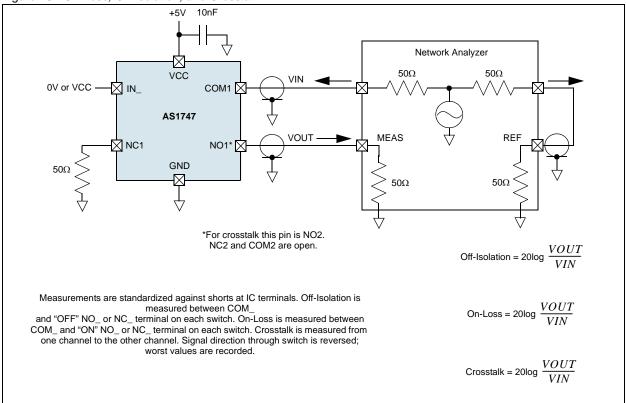
Figure 16. Break-Before-Make Interval









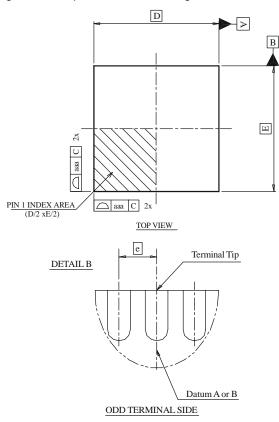


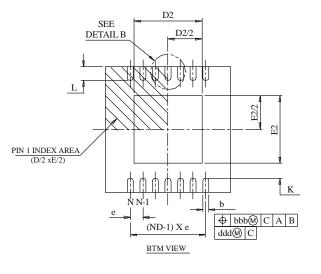


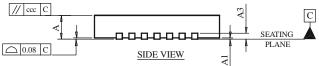
11 Package Drawings and Markings

The devices are available in 10-pin TDFN 3x3 package.

Figure 19. 10-pin TDFN 3x3 Package Dimensions







Symbol	Min	Nom	Max		
А	0.70	0.75	0.80		
A1	0.00	0.02	0.05		
A3		0.20 REF			
θ	0° 14°				
aaa	0.15				
bbb	0.10				
CCC	0.10				
ddd	0.05				
eee	0.08				
ggg	0.10				

Symbol	Min	Nom	Max				
D BSC	3.00						
E BSC		3.00					
D2	2.20		2.70				
E2	1.40		1.75				
L	0.30	0.40	0.50				
K	0.20						
b	0.18	0.25	0.30				
е	0.50						
Ν	10						
ND		5					

Notes:

- 1. Figure 19 is shown for illustration only.
- 2. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
- 3. All dimensions are in millimeters, angle is in degrees.
- 4. N is the total number of terminals.
- 5. ND refers to the maximum number of terminals on D side.

12 Ordering Information

The devices are available as the standard products shown in Table 4.

Table 4. Ordering Information

Model	Description	Delivery Form	Package
AS1/4/-BIDI	Dual 0.60hm SPDT, Audio Clickless Switch with	Tape & Reel	10-pin TDFN
	Negative Rail Capability		(3.0mm x 3.0mm)

Note: All products are RoHS compliant and Pb-free.

Buy our products or get free samples online at ICdirect: http://www.austriamicrosystems.com/ICdirect

For further information and requests, please contact us mailto:sales@austriamicrosystems.com or find your local distributor at http://www.austriamicrosystems.com/distributor

Copyrights

Copyright © 1997-2009, austriamicrosystems AG, Tobelbaderstrasse 30, 8141 Unterpremstaetten, Austria-Europe. Trademarks Registered ®. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

All products and companies mentioned are trademarks or registered trademarks of their respective companies.

Disclaimer

Devices sold by austriamicrosystems AG are covered by the warranty and patent indemnification provisions appearing in its Term of Sale. austriamicrosystems AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. austriamicrosystems AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with austriamicrosystems AG for current information. This product is intended for use in normal commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by austriamicrosystems AG for each application. For shipments of less than 100 parts the manufacturing flow might show deviations from the standard production flow, such as test flow or test location.

The information furnished here by austriamicrosystems AG is believed to be correct and accurate. However, austriamicrosystems AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of austriamicrosystems AG rendering of technical or other services.



Contact Information

Headquarters

austriamicrosystems AG Tobelbaderstrasse 30 A-8141 Unterpremstaetten, Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

For Sales Offices, Distributors and Representatives, please visit: http://www.austriamicrosystems.com/contact